

DOCKET NO: 243197US2

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF
YUKITAKA HORI, ET AL.

SERIAL NO: 10/669,558

RCE FILED: HEREWITH

FOR: SEMICONDUCTOR DEVICE
HAVING SEALING STRUCTURE FOR
WIDE GAP TYPE SEMICONDUCTOR
CHIP

RECEIVED
: EXAMINER: LONG PHAM OCT 11 2005
: GROUP ART UNIT: 2814 **OFFICE OF PETITIONS**
: **DATE ALLOWED: JULY 8, 2005**
: (APPLICATION FILED SEPTEMBER 25, 2005)

PETITION TO WITHDRAW FROM ISSUE UNDER 37 CFR § 1.313(c)

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

ATTN: OFFICE OF PETITIONS

SIR:

This is a petition to withdraw the above-identified application from issue pursuant to 37 CFR §1.313(c)(2) so that a Request for Continuation Examination Under 37 C.F.R. § 1.114(a)(1) and an Information Disclosure Statement may be considered upon the granting of this petition.

In accordance with 37 CFR §1.17(i) the required fee for filing this 37 CFR §1.313 petition is included herewith.

Accordingly, it is respectfully requested that the petition be granted, that the above-identified application be withdrawn from issue, that the Request for Continued Examination be granted, and that the accompanying references be considered.

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130.00 OP

Application No. 10/669,558
Petition To Withdraw From Issue Under 37 C.F.R. § 1.313(c)

If there are any questions regarding this Petition or the application in general, a telephone call to the undersigned would be appreciated.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.



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